

NCEP12T10F

NCE N-Channel Super Trench Power MOSFET

Description

The NCEP12T10F uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{DS(ON)}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

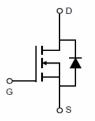
General Features

- V_{DS} =120V, I_D =100A $R_{DS(ON)}$ =6.8m Ω (typical) @ V_{GS} =10V
- Excellent gate charge x R_{DS(on)} product(FOM)
- Very low on-resistance R_{DS(on)}
- 175 °C operating temperature
- Pb-free lead plating
- 100% UIS tested

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

100% UIS TESTED! 100% ΔVds TESTED!



Schematic Diagram



Marking and pin assignment



TO-220F top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCEP12T10F	NCEP12T10F	TO-220F	-	-	-

Absolute Maximum Ratings (T_C=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	120	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current-Continuous	I _D	100	А
Drain Current-Continuous(T _C =100℃)	I _D (100℃)	70.7	Α
Pulsed Drain Current	I _{DM}	400	Α
Maximum Power Dissipation	P _D	40	W
Derating factor		0.27	W/°C
Single pulse avalanche energy (Note 5)	E _{AS}	460	mJ
Operating Junction and Storage Temperature Range	T_{J} , T_{STG}	-55 To 175	$^{\circ}$ C

Thermal Characteristic

Thermal Resistance, Junction-to-Case ^(Note 2)	$R_{ heta JC}$	3.75	°C/W	
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NCEP12T10F

Electrical Characteristics (T_C=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	120		-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =120V,V _{GS} =0V	-	-	1	μΑ
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20 V , V_{DS} =0 V	-	-	±100	nA
On Characteristics (Note 3)				•		
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	2.5	_	4.5	V
Drain-Source On-State Resistance	R _{DS(ON)}	V_{GS} =10V, I_D =50A	-	6.8	7.6	mΩ
Forward Transconductance	g FS	V _{DS} =5V,I _D =50A	-	50	-	S
Dynamic Characteristics (Note4)				•		
Input Capacitance	C _{lss}		-	3458	-	PF
Output Capacitance	C _{oss}	V_{DS} =50V, V_{GS} =0V,	-	500	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz - 18 -		-	PF	
Switching Characteristics (Note 4)				•		
Turn-on Delay Time	t _{d(on)}		-	35	-	nS
Turn-on Rise Time	t _r	V_{DD} =60 V , I_D =50 A	-	14	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10 V , R_{G} =3 Ω	-	55	-	nS
Turn-Off Fall Time	t _f		-	18	-	nS
Total Gate Charge	Qg	\/ CO\/ FOA	-	55	-	nC
Gate-Source Charge	Q _{gs}	$V_{DS}=60V, I_{D}=50A,$	-	20		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	16		nC
Drain-Source Diode Characteristics				•		
Diode Forward Voltage (Note 3)	V_{SD}	V _{GS} =0V,I _S =50A	-		1.2	V
Diode Forward Current (Note 2)	Is		-	-	100	Α
Reverse Recovery Time	t _{rr}	$T_J = 25^{\circ}C, I_F = I_S$	-	85	-	nS
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-	200	-	nC

Notes:

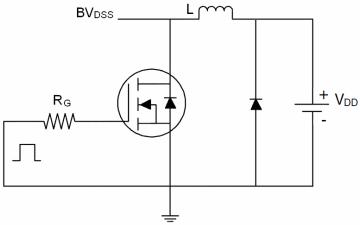
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, $t \le 10$ sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25 $^{\circ}\text{C}$,V $_{\text{DD}}$ =20V,V $_{\text{G}}$ =10V,L=0.5mH,Rg=25 Ω

Pb Free Product

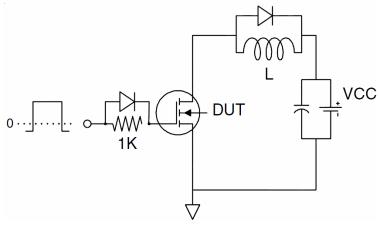


Test Circuit

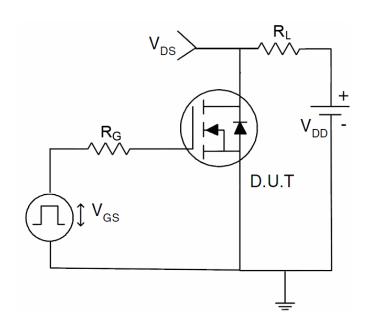
1) E_{AS} test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit







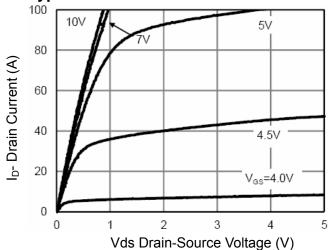


Figure 1 Output Characteristics

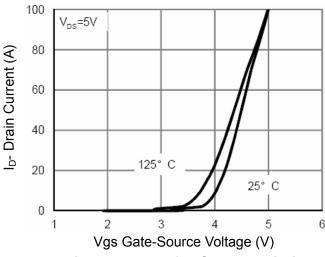


Figure 2 Transfer Characteristics

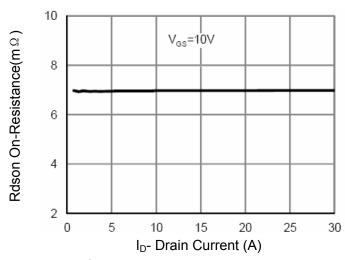


Figure 3 Rdson- Drain Current

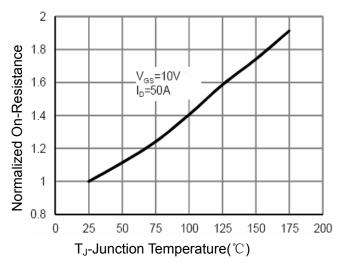


Figure 4 Rdson-Junction Temperature

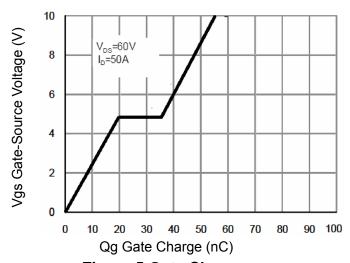


Figure 5 Gate Charge

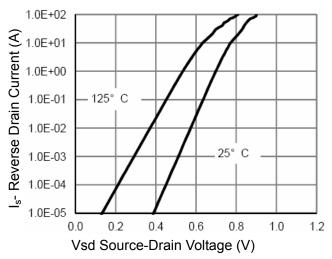


Figure 6 Source- Drain Diode Forward



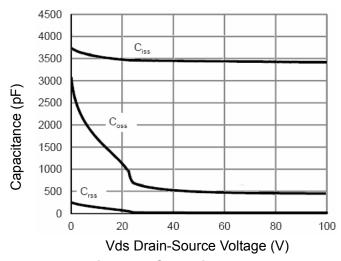


Figure 7 Capacitance vs Vds

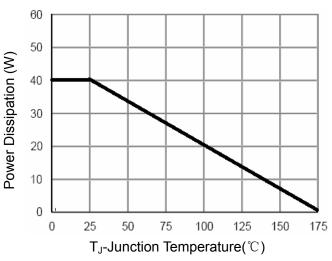


Figure 9 Power De-rating

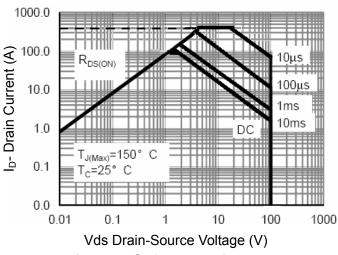


Figure 8 Safe Operation Area

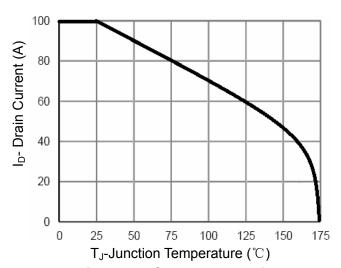


Figure 10 Current De-rating

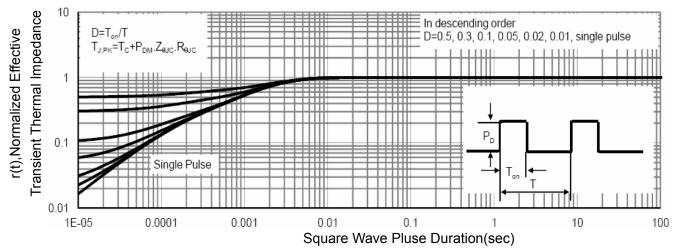
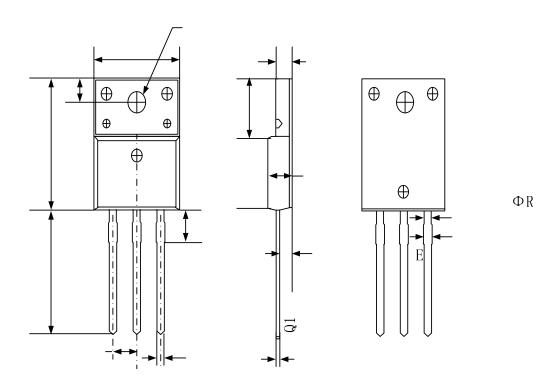


Figure 11 Normalized Maximum Transient Thermal Impedance





TO-220F Package Information



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
Α	4.50	4.83	0. 18	0. 19	
b	0.70	0.91	0.03	0.04	
b1	1.20	1.47	0.05	0.06	
b2	1.10	1.38	0. 04	0.05	
С	0.45	0.63	0.02	0.02	
D	15.67	16.07	0.62	0. 63	
е	2.54	BSC	0.10	BSC -	
E	9.96	10.36	0.39	0.41	
F	2.34	2.74	0.09	0. 11	
G	6.48	6.90	0. 26	0. 27	
L	12.68	13.30	0. 50	0. 52	
L1	3.13	3.50	0. 12	0. 14	
Q	2.56	2.93	0. 10	0. 12	
Q1	3.20	3.40	0. 13	0. 13	
ΦR	3.08	3.28	0. 12	0. 13	

2x€

3xb



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NCEP12T10F

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